



BSI Standards Publication

Circuit boards and circuit board assemblies — Design and use

Part 6-2: Land pattern design — Description of land pattern for the most common surface mounted components (SMD)

National foreword

This British Standard is the UK implementation of EN IEC 61188-6-2:2021. It is identical to IEC 61188-6-2:2021.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic Assembly Technology.

A list of organizations represented on this committee can be obtained on request to its committee manager.

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